



Climbing film, flooding and falling film behavior in upflow condensation in tubes



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ARTICLE INFO

Article history:

Received 15 May 2013

Received in revised form 24 May 2013

Accepted 28 May 2013

Available online 22 June 2013

Keywords:

Condensation

Annular flow

Flooding

ABSTRACT

Upflow condensation in vertical tubes is complicated by the relative magnitude of the opposing vapor shear and gravity. This study examines the different flow regimes for condensation of FC-72 in a vertical tube using both high-speed video imaging and detailed heat transfer measurements. Four regimes are identified, falling film, where the condensing film drains downwards by gravity opposite to low velocity vapor flow, oscillating film, corresponding to film flow oscillating between upwards and downwards, flooding, where film begins to be sheared upwards by the vapor core, and climbing film, where high vapor velocity causes the film to be sheared upwards. The four flow regimes are well segregated in a flow regime map based on dimensionless superficial velocities of the vapor and liquid. The condensation heat transfer coefficient is shown to decrease axially because of gradual thickening of the film, except for high mass velocities, where turbulence and intensified interfacial waviness cause downstream heat transfer enhancement. An annular flow model is constructed, which shows fair predictions for the climbing film regime. The predictive accuracy of the model is influenced by flow oscillations occurring downstream of the climbing film region and inability of the model to account for interfacial waves.

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1. Introduction

The recent increase in heat dissipation in electronic and power devices and systems has spurred interest in the development of compact, high-power-density phase-change thermal management systems that tackle both the heat acquisition from the device by boiling or evaporation, and the heat rejection to the ambient by condensation. These systems are becoming increasingly important to the development of high performance computers, electric vehicle power electronics, avionics, and directed energy laser and microwave weapon systems [1]. Different configurations have been proposed for heat acquisition by boiling, including pool boiling [2,3], channel flow boiling [4,5], jet [6–8] and spray [9,10], as well as enhanced surfaces [11,12] and hybrid cooling configurations [13,14]. However, far less emphasis has been placed on the condensation, or heat rejection part of these systems.

Much of the condensation knowhow and design models come from early research related to condensers found in power generation, chemical, and refrigeration and air conditioning industries. These condensers come in a variety of configurations, including falling film condensation on the outside of horizontal tubes in shell-and-tube heat exchangers, and inside horizontal, vertical

and inclined tubes. The present study concerns internal upflow condensation in vertical tubes.

Condensation inside tubes takes the form of a number of flow regimes, which, in the order of decreasing quality, include pure vapor, annular, slug, bubbly and pure liquid [15]. Drastic differences in flow structure between these regimes have led investigators to construct flow regime maps and develop flow regime transition relations [16–21] that enable identification of regimes based on measurable parameters, and to develop models that are specific to individuals regimes. The annular regime, which consists of a thin film surrounding a vapor core, has been the focus of most studies on condensation in tubes because of its prevalence over a large fraction of the tube length and its ability to deliver very large heat transfer coefficients.

Vertical upflow condensation is encountered when the vapor is supplied upwards from the bottom of a vertical tube. At low vapor velocities, a *falling film* regime is encountered, where the condensing liquid film is driven downwards by gravity, opposite to the direction of the vapor flow. This regime is highly complicated by the role of interfacial waves, and is reminiscent of the complex interfacial behavior encountered in flow boiling at low velocities in vertical downflow [22–25]. Increasing the vapor velocity increases the vapor shear exerted on the film interface, which begins to slow the downward motion of the liquid film. A particular vapor velocity is reached that causes the interfacial portion of the film to be carried upwards rather than drain to the bottom. This condition

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